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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/808,298	03/25/2004	Tetsuya Kurosawa	02887.0271	5493
22852 75	90 06/28/2005		EXAMINER	
FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER			OSELE, MARK A	
LLP 901 NEW YOR	K AVENUE, NW		ART UNIT	PAPER NUMBER
	N, DC 20001-4413		1734	
			D. 100 14 15 05 05 06 00 000	

DATE MAILED: 06/28/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

				
Application No.	Applicant(s)			
10/808,298	KUROSAWA			
Examiner	Art Unit			
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4) Interview	Summary (PTO-413)			
5) D Notice of	Informal Patent Application (PTO-152)			
	Examiner Mark A. Osele ars on the cover sheet IS SET TO EXPIRE 3 (a). In no event, however, may within the statutory minimum of the apply and will expire SIX (6) Mause the application to become atte of this communication, event attended to the communication, event attended to the communication. In the except for formal may parte Quayle, 1935 Communication. In the certified or by a communication or consideration. In the certified copies not be compared to the compared	Examiner Mark A. Osele ars on the cover sheet with the correspondence address IS SET TO EXPIRE 3 MONTH(S) FROM (a). In no event, however, may a reply be timely filed within the statutory minimum of thirty (30) days will be considered timely, apply and will expire SIX (6) MONTHS from the mailing date of this communication to become ABANDONED (35 U.S.C. § 133). atte of this communication, even if timely filed, may reduce any action is non-final. the except for formal matters, prosecution as to the mention parte Quayle, 1935 C.D. 11, 453 O.G. 213. In from consideration. Accepted or b) objected to by the Examiner. Examiner awing(s) be held in abeyance. See 37 CFR 1.85(a). In is required if the drawing(s) is objected to. See 37 CFR 1.12 miner. Note the attached Office Action or form PTO-152 miner. Note the attached Office Action or form PTO-152 miner been received. The part of the pa		

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-2, 6, 10-14, 20 rejected under 35 U.S.C. 102(b) as being anticipated by Watanabe et al. Watanabe et al. shows a method and apparatus for peeling a pressure sensitive adhesive tape from a semiconductor wafer constituted by a plurality of semiconducor chips wherein the apparatus comprises a peeling mechanism with a sucking section having a porous member to hold the semiconductor wafer by suction, the porous member being segmented into a plurality of sucking areas in the direction in which the tape is peeled wherein the vacuum in each of the sections can be turned on and off (column 8, lines 25-36). After peeling of the tape the chips are lifted with a vacuum collet (column 6, lines 13-18).

Regarding claim 20, the claimed method does not require that the adhesive on the tape and the wafer are two separate adhesives.

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and

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the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

- 4. Claims 3, 7-9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Watanabe et al. As shown in paragraph 2 above, Watanabe et al. shows the instantly claimed invention except for the cutting mechanism for the adhesive tape. Watanabe et al. shows that in one embodiment the adhesive tape can be cut (Fig. 11; column 9, lines 31-46). It would have been obvious to one of ordinary skill in the art at the time the invention was made to add a cutter to the apparatus of Watanabe et al.
- 5. Claims 3, 7-9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Watanabe et al. in view of Miyamoto et al. As shown in paragraph 2 above, Watanabe et al. shows the instantly claimed invention except for the heater in the apparatus. Miyamoto et al. teaches that wafer adhesive tapes can have their adhesive strength weakened by heat (column 16, lines 30-46). It would have been obvious to one of ordinary skill in the art at the time the invention was made to add a heater to the apparatus of Watanabe et al. so it can reduce the strength of the adhesive tape and make peeling of the tape easier.

Allowable Subject Matter

6. Claims 15-19 and 21-25 are allowed.

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7. Claim 5 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

8. The following is a statement of reasons for the indication of allowable subject matter: None of the prior art suggests an adhesive layer on the wafer opposite the adhesive sheet nor cutting the wafer after peeling of the tape. The tape of Watanabe et al. is a dicing tape used to hold the wafer in position after dicing. In addition, none of the prior art suggests using a laser to be applied to the semiconductor chip with an incidence angle of 20° and 40°.

Conclusion

- 9. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Yamasaki and Choi show vacuum holding members with a plurality of vacuum sections.
- 10. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Mark A. Osele whose telephone number is 571-272-1235. The examiner can normally be reached on M-F 9:30-6:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Christopher Fiorilla can be reached on 571-272-1187. The fax phone

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number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

MARK A. OSELE PRIMARY EXAMINER

June 27, 2005